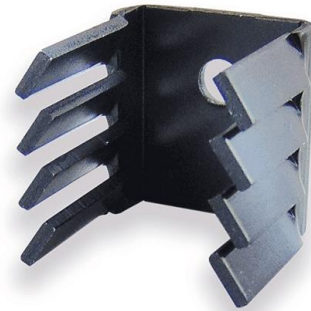


## Product Data Sheet Type: FI355/19/SE

Group: HEATSINKS Board Level

For single mounting

Width :	22 mm
Height :	19.2 mm
Length :	19 mm
Minimum thermal resistance :	21 K/W
For device :	TO 220
Device mounted by :	Screw
Heatsink mounted by :	Srew-On
Surface :	Black Anodised
Material :	Al99,5



Finger shaped heatsink, for semiconductor case TO 220.  
For screw and rivet mounting  
Turbulence in every installation position

